

	Type	Hits	Search Text	DBs
17	BRS	141857	amorph\$	USPAT; US-PGPUB
18	BRS	760656	carbon or carbide	USPAT; US-PGPUB
19	BRS	29028	boron with (carbon or carbide)	USPAT; US-PGPUB
20	BRS	1005	amorph\$ with (boron with (carbon or carbide))	USPAT; US-PGPUB
21	BRS	880012	substrate or wafer or semiconductor	USPAT; US-PGPUB
22	BRS	679	(amorph\$ with (boron with (carbon or carbide))) and (substrate or wafer or semiconductor)	USPAT; US-PGPUB
23	BRS	13	(substrate or wafer or semiconductor) and (bc with amorph\$)	USPAT; US-PGPUB

	Type	Hits	Search Text	DBs
48	BRS	142273	amorph\$	USPAT; US-PGPUB
49	BRS	63	((arc or antireflect\$ or reflect\$ or barc or darc) with (((boron with (carbon or carbide)))))) and amorph\$	USPAT; US-PGPUB
50	BRS	882611	substrate or wafer or semiconductor	USPAT; US-PGPUB
51	BRS	57	((arc or antireflect\$ or reflect\$ or barc or darc) with (((boron with (carbon or carbide)))))) and amorph\$) and (substrate or wafer or semiconductor)	USPAT; US-PGPUB
52	BRS	152	(arc or antireflect\$ or reflect\$ or barc or darc) with (((boron with (carbon or carbide)))))	EPO; JPO; DERWENT; IBM_TDB
53	BRS	1883043	substrate or wafer or semiconductor	EPO; JPO; DERWENT; IBM_TDB
54	BRS	20	((arc or antireflect\$ or reflect\$ or barc or darc) with (((boron with (carbon or carbide)))))) and (substrate or wafer or semiconductor)	EPO; JPO; DERWENT; IBM_TDB